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ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP. RoHS & Halogen Free & REACH Compliance.

SPECIFICATION FOR APPROVAL

Customer :			國益興業	
Customer P/N:				
Drawing No:				
Quantity:	Х	Pcs.	Date :	2016/11/28
Chilisin P/N:		HEI2	01610K-1R0)M-Q8DG

SPEC	CIFICATION
ACC	EPTED BY:
COMPONENT	
ENGINEER	
ELECTRICAL	
ENGINEER	
MECHANICAL	
ENGINEER	
APPROVED	
REJECTED	
奇力新電子股份有限公司	東莞奇力新電子有限公司
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http://www.chilisin.com.tw 奇力新電子(河南)有限公司	E-mail:cect@chilisin.com.tw 蘇州奇益新電子有限公司
Chilisin Electronics (Henan) Co., Ltd. XiuWu Xian, industry gathering area JiaoZuo, Henan China	SUZHOU QI YIXIN Electronics Co., Ltd. No.143,Song Shan Rd., Suzhou New District,

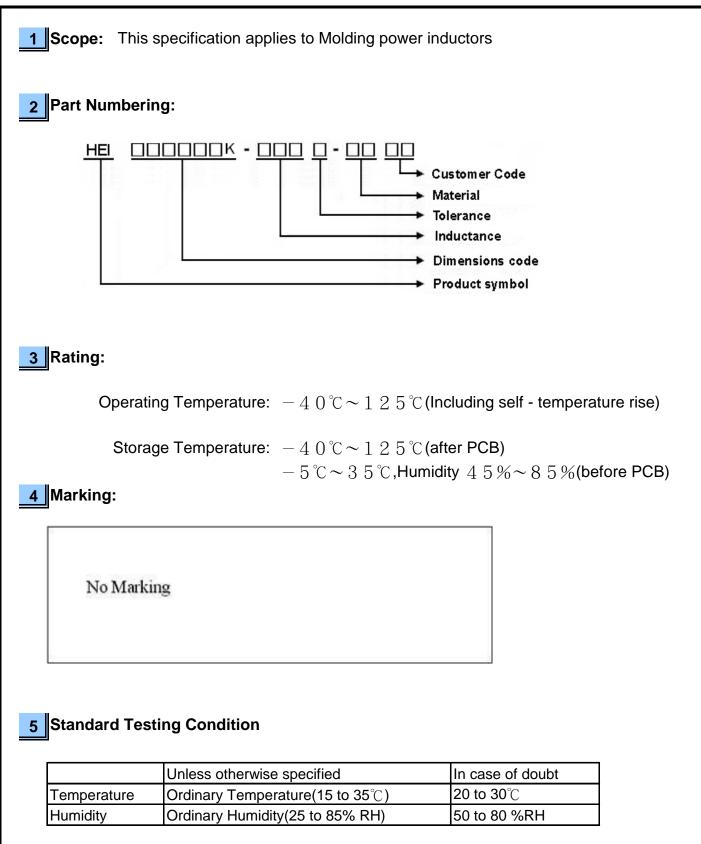
SUZHOU QI YIXIN Electronics Co., Lt No.143,Song Shan Rd., Suzhou New Suzhou,China Postal Code:215129 TEL:+86-512-6841-2350 FAX:+86-512-6841-2356 E-mail : suzhou@chilisin.com.tw

Drawn byChecked byApproved by張鈺雯 Chang.Yuwen張鈺雯 Chang.Yuwen鍾瑞民 Jacky.Chung



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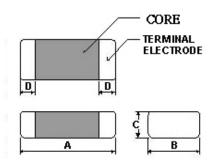
HEI201610K Series Specification





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6 Configuration and Dimensions:



Dimensions in mm					
TYPE	HEI201610K				
А	2.0±0.2				
В	1.6±0.2				
С	1.0Max.				
D	0.5±0.3				

7 Electrical Characteristics:

Part No.	Inductance (uH)	Tolerance (±%)	Test Freq.	Irms(A) Max.(Typ)	Isat(A) Max.(Typ)	RDC(mΩ) Max.(Typ)	
HEI201610K-1R0M-Q8DG	1.0	20	2MHz,0.2V	3.1(3.25)	4.0(4.1)	56(50)	

NOTE:

1.Operating temperature range $-~4~0~\% \sim 1~2~5~\%$ (Including self - temperature rise)

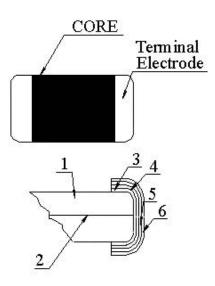
2.Isat for Inductance drop 30% from its value without current.

- 3.Irms for a 40 $^\circ\!\mathrm{C}$ temperature rise from 25 $^\circ\!\mathrm{C}$ ambient.
- 4.All test data is referenced to $\rm 25^\circ\!C$ ambient



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8 HEI201610K Series 8.1 Construction:



8.2 Material List:

NO	Part	Description
1	Core	Metal Powder
2	Wire	Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn



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9 Reliability of Molding Power Inductor

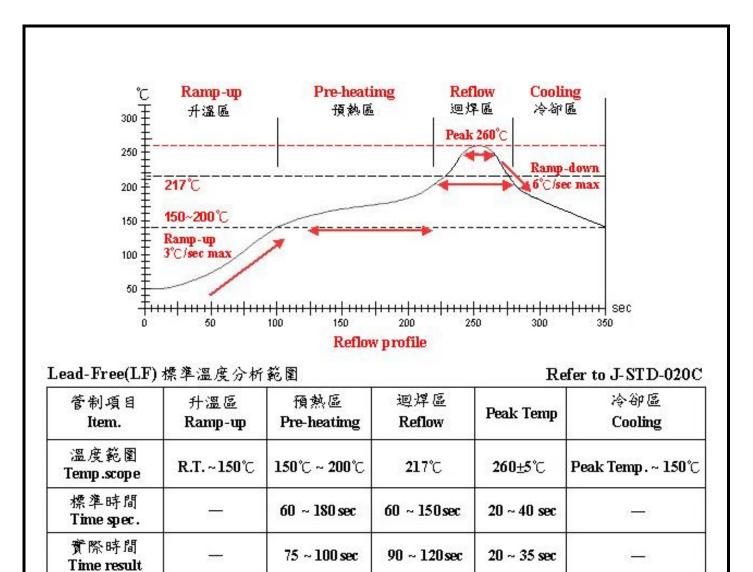
1-1.N	lechanical	Performance

No	lechanical Performance Item	Specification		Test Method	
-	Flexure Strength	The forces applied on the right	Test d	evice shall be soldered on the substrat	e
		conditions must not damage			0
		the terminal electrode and the			
		metal body	Keeping Time: 30sec		
		inclar body	Reepi		
1-1-2	Vibration	Appearance:No damage (for	Test device shall be soldered on the substrate		
		microscope of CASTOR MZ-45 20X)		ation Frequency: 10 to 55 to 10Hz for 1	min
		Inductance change shall be	-	ude: 1.5mm	
		within ±20%		2hrs for each axis (X, Y & Z), total 6hrs	
1-1-3	Resistance to Soldering Heat	Appearance: No damage		eating: 150 $^\circ\!\!\mathbb{C}$, 1min	
		More than 75% of the terminal.	Solde	r Composition: Sn/Ag3.0/Cu0.5(Pb-Free	e)
		electrode should be covered	Solde	r Temperature: 260±5℃	
		with solder.	Immer	sion Time: 10±1sec	
		Inductance: within ±20% of			
		initial value			
1-1-4	Solder ability	The electrodes shall be at	Pre-he	eating: 150°C, 1min	
		least 95% covered with new	Solde	r Composition: Sn/Ag3.0/Cu0.5(Pb-Free	e)
		solder coating	Solder Temperature: 245±5°C		
			Immersion Time: 4±1sec		
1-1-5	Terminal Strength Test	No split termination	Test d	evice shall be soldered on the substrat	e,
		Chip	then apply a force in the direction of the arrow.		
		F	Force : 5N		
			Keeping Time: 10±1sec		
		Mounting Pad			
1-2.E No	nvironmental Performance	Specification		Test Method	
	Temperature Cycle	Specification Appearance: No damage	One c		
1-2-1		Inductance: within±20% of	Step		Time (min)
		initial value	3tep	Temperature (℃) -40±3	30
			2	-40±3 25±2	30
			2		
			-	125±3	30
			4 Total:	25±2	3
				100cycles ured after exposure in the room condition	n for 24bre
1-2.2	Humidity Resistance	1		· · · · · · · · · · · · · · · · · · ·	1101 241115
1-2-2				erature: $60\pm2^{\circ}$ ve Humidity: 90 ~ 95% / Time: 500hrs	
				-	n for 24bra
1 2 2	High	1		ured after exposure in the room condition	01101Z4111S
1-2-3	-			erature: 85±3°C	
	Temperature Resistance			ve Humidity: 0% / Time: 500hrs ured after exposure in the room condition	n for 24bre
121	Low	1		· · · · · · · · · · · · · · · · · · ·	1101 241115
1-2-4				erature: $-40\pm3^{\circ}$ C	
	Temperature Resistance			ve Humidity: 0% / Time: 500hrs	n for 24bra
	1		weast	ured after exposure in the room condition	IT IOF Z4NTS



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NOTE :

1. Re-flow possible times : within 2 times

2. Nitrogen adopted is recommended while in re-flow



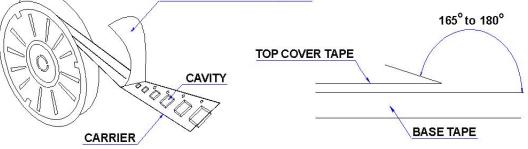
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10 Packaging:

10.1 Packaging -Cover Tape

The force for tearing off cover tape is 10 to 100 grams in the arrow direction.

THICKNESS: 0.1(0.004)MAX.



10.2 Packaging Quantity

TYPE	PCS/REEL
HEI201610K	3000

10.3 Reel Dimensions

	11	Dimensions in m	nm			
		TYPE	А	В	С	D
	B	HEI201610K	178	60	12	1.5
A						

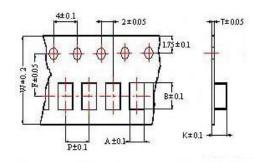


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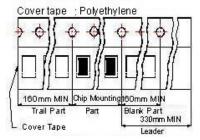
10 Packaging:

10.4 Tape Dimensions in mm



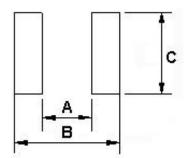
Tape Material

Carrier tape : Polycarbonate



ТҮРЕ	Α	В	Т	W	Р	F	K
HEI201610K	1.80	2.20	0.22	8	4	3.5	1.15

11 Recommended Land Pattern:



Dimensions in mm

TYPE	А	В	С
HEI201610K	0.7	2.3	1.8

12 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose, under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5.After manufacturing process, there might be slight irregular shape on the edge of the products, and it's a normal phenomenon that can be neglected
- 6. The moisture sensitivity level (MSL) of products is classified as level 1.



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